10-21-2002 RE(HEET U.S. DEPARTMENT OF COMMERCE PTO-1595 Patent and Trademark Office 102255191 To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof. 1 Name of conveying party(ies): Name and address of receiving party(ies): Taiwan Semiconductor Manufacturing Co. Ltd. Chih-Fu Chang No. 121 Park Avenue 3 Yu-Chun Huang Science-Based Industrial Park Hsin-Chu, Taiwan, R.O.C. Additional name(s) & address(es) attached □ Yes 図 No Nature of conveyance: Merger Assignment Change of Name Security Agreement Other: Execution Date: October 1, 2002 Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: 10-01-02B. Patent No(s) A. Patent Application No(s). Additional numbers attached? □ Yes ⊠ No 5 Name and address of party to whom correspondence Total number of applications and patents involved: concerning document should be mailed: Total fee (37 CFR 3.41) \$40.00 RANDY W. TUNG Tung & Associates 838 W. Long Lake Road **Enclosed** Suite 120 Bloomfield Hills, Michigan 48302 Authorized to charge credit card (w/filing fee) Deposit Account Number: 50-0484 10/16/2002 FFANAEIA 00000021 10268511 (Attach duplicate copy of this page if paying by deposit 40.00/DP 02 FC**:80**21 account) DO NOT USE THIS SPACE 9 Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of

the original document.

Randy W. Tung Name of Person Signing Registration No. 31,311

Signature

October 10, 2002 Date

Total number of pages including cover sheet, attachments, and document : 3

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

> **PATENT** REEL: 013388 FRAME: 0238

ASSIGNMENT

WHEREAS, we, <u>CHIH-FU CHANG and YU-CHUN HUANG</u>, have invented certain improvements in

METHOD FOR FORMING A TAPERED DUAL DAMASCENE

VIA PORTION WITH IMPROVED PERFORMANCE

for which we are about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

1

PATENT REEL: 013388 FRAME: 0239 67,200-893 2001-1759

application thereof, and in and to any reissue of any such patent, and in and to any patent

applications which may be filed on said invention in countries foreign to the United States and any

Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said invention

in its own name or through its designees, including subsidiaries, related companies or assignees,

under the International Convention or otherwise, and we further agree to execute all papers,

including those required for the United States and foreign applications, and to perform such other

proper acts as said corporation or its designees the rights herein assigned.

CHIH-FU CHANG

Yu-Chun Huung

TUNG & ASSOCIATES 838 W. Long Lake Road Suite 120

Bloomfield Hills, Michigan 48302

2

PATENT REEL: 013388 FRAME: 0240